## **Discription**

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a ultra-small and flat lead SOD-323 plastic package designed to protect one signal line from the damage caused by ESD and other transients.



**Features** SOD-323

★ Bidirectional ESD protection of one line

★ Reverse stand-off voltage: 24.0V Max

★ Low leakage current: nA Level

★ Response time is typically < 1 ns</p>

★ Low clamping voltage: VC < 45 V @ IPP = 18A

★ ESD Protection: 30kV(air)/30kV(contact) (IEC61000-4-2)

★ RoHS compliant



**Applications** 

★ Cell Phone Handsets and Accessories

★ Microprocessor based equipment

★ Personal Digital Assistants (PDA's)

★ Notebooks, Desktops, and Servers

Circuit Diagram

## Orderingin formation

Product ID	Pack	Qty(PCS)
PESD24VL1BA	SOD-323	3000



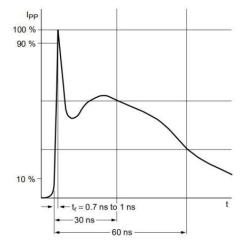
# Absolute Ratings(Tamb = 25°C)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp = 8/20µs)	РРРМ	430	W
Peak Pulse Current(tp = 8/20µs)	ІРРМ	9.5	А
ESD voltage IEC 61000-4-2 (air discharge)	Vesd	15	kV
ESD voltage IEC 61000-4-2 (contact discharge)	Vesd	8	kV
Maximum lead temperature for soldering during 10s	T∟	260	°C
Storage Temperature Range	Tstg	-55 to +150	°C
Operating Temperature Range	Тор	-40 to +125	°C

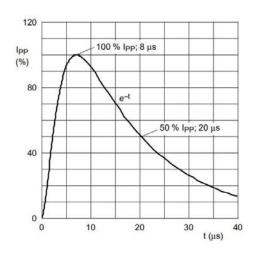
## **Electrical Characteristics**

Parameter	Symbol	Min	Тур	Max	Unit	Condition	
Reverse Working Voltage	VRWM			24.0	V		
Breakdown Voltage	V <sub>BR</sub>	26.0			V	I⊤=1mA	
Leakage Current ILeak	lR			1.0	uA	V <sub>RWM</sub> =12V	
Clamping Valtage	Vc			14.0	V	IPP=10A,Tp=8/20µs	
Clamping Voltage	Vc			45.0	V	І <sub>РР</sub> =18А,Тр=8/20µs	
Junction Capacitance	Сл		30		pF	V <sub>R</sub> =0V, f=1MHz	

# **Typical Characteristics**



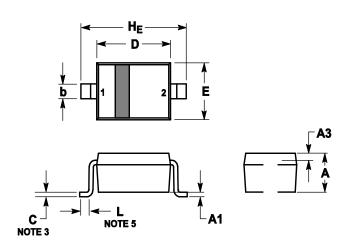
IEC61000-4-2 Waveform



IEC 61000-4-5 Waveform( 8/20µs pulse)



#### **Outline And Dimensions**

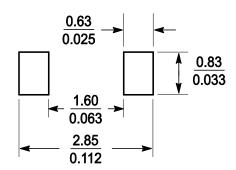


#### Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

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	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	8.0	0.9	1	0.031	0.035	0.04
A1	0	0.05	0.1	0	0.002	0.004
А3	0.15REF			0.006REF		
b	0.25	0.32	0.4	0.01	0.012	0.016
С	0.089	0.12	0.177	0.003	0.005	0.007
D	1.6	1.7	1.8	0.062	0.066	0.07
Е	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
H <sub>E</sub>	2.3	2.5	2.7	0.09	0.098	0.105

# **Soledering Footprint**



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